

V <sub>DSS</sub>	-30V
$R_{DS(on)}(Max.)$	$45 \mathrm{m}\Omega$
Ι <sub>D</sub>	-4A
P <sub>D</sub>	1W

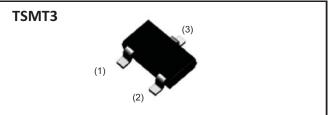
### Features

- 1) Low on resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (TSMT3).
- 4) Pb-free lead plating ; RoHS compliant
- 5) AEC-Q101 Qualified

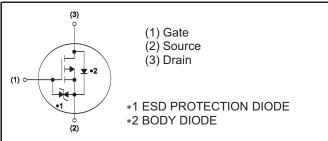
### Application

DC/DC converters

#### Outline



#### Inner circuit



#### Packaging specifications

	Packaging	Taping
	Reel size (mm)	180
Tupo	Tape width (mm)	8
Туре	Basic ordering unit (pcs)	3,000
	Taping code	TL
	Marking	UG

## ●Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	-30	V
Continuous drain current	ا <sub>D</sub> *1	±4	А
Pulsed drain current	I <sub>D,pulse</sub> *2	±16	А
Gate - Source voltage	V <sub>GSS</sub>	±20	V
Dower dissinction	P <sub>D</sub> <sup>*3</sup>	1.0	W
Power dissipation	P <sub>D</sub> <sup>*4</sup>	0.54	W
Junction temperature	Тj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

### RRR040P03FRA

#### •Thermal resistance

Parameter	Symbol	Values			Unit
	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - ambient	R <sub>thJA</sub> *3	-	-	125	°C/W
Thermal resistance, junction - ambient	$R_{thJA}$ *4	-	-	231	°C/W

## •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Symbol	Conditions	Values			Unit	
Parameter			Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	V <sub>GS</sub> = 0V, I <sub>D</sub> = -1mA	-30	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I <sub>D</sub> = -1mA referenced to 25°C	-	-25	-	mV/°C	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30V, V_{GS} = 0V$	-	-	-1	μA	
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	-	-	±10	μA	
Gate threshold voltage	$V_{GS\ (th)}$	$V_{DS} = -10V, I_{D} = -1mA$	-1	-	-2.5	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{(GS)th}}{\Delta T_{j}}$	I <sub>D</sub> = −1mA referenced to 25°C	-	3.9	-	mV/°C	
		V <sub>GS</sub> = -10V, I <sub>D</sub> =-4A	-	32	45		
Static drain - source	- *5	V <sub>GS</sub> = -4.5V, I <sub>D</sub> =-2A	-	45	63		
on - state resistance	R <sub>DS(on)</sub> <sup>5</sup>	$V_{GS}$ = -4.0V, $I_{D}$ =-2A	-	52	72	mΩ	
		V <sub>GS</sub> = –10V, I <sub>D</sub> = –4A, T <sub>j</sub> =125°C	-	47	66		
Gate input resistannce	R <sub>G</sub>	f = 1MHz, open drain	-	13	-	Ω	
Transconductance	g <sub>fs</sub> *5	$V_{DS} = -10V, I_{D} = -4A$	2.7	7.2	-	S	

\*1 Limited only by maximum temperature allowed.

\*2 Pw  $\leq$  10 $\mu s,$  Duty cycle  $\leq$  1%

\*3 Mounted on a ceramic boad (30×30×0.8mm)

\*4 Mounted on a FR4 (12×20×0.8mm)

## •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	1000	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -10V	-	150	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	130	-	
Turn - on delay time	t <sub>d(on)</sub> *5	$V_{DD} \simeq -15V, \ V_{GS} = -10V$	-	15	-	
Rise time	t <sub>r</sub> *5	I <sub>D</sub> = -2A	-	30	-	20
Turn - off delay time	t <sub>d(off)</sub> *5	$R_L = 7.5\Omega$	-	85	-	ns
Fall time	t <sub>f</sub> *5	R <sub>G</sub> = 10Ω	-	45	-	

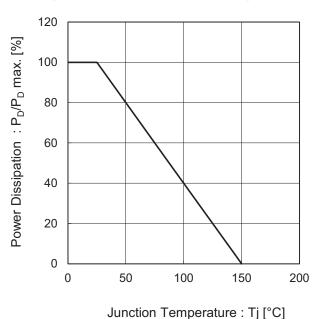
# •Gate Charge characteristics ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Conditions	Values			Unit	
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Total gata charge	$Q_{a}^{*5}$	o <sup>*5</sup>	$V_{DD} \simeq -15V, I_D = -4A$ $V_{GS} = -5V$	-	10.5	-	
Total gate charge		$V_{DD} \simeq -15V$ , $I_D = -4A$ $V_{GS} = -10V$	-	20	40	nC	
Gate - Source charge	$Q_{gs}$ *5	$V_{DD} \simeq -15V$ , $I_D = -4A$ $V_{GS} = -10V$	-	3.0	-		
Gate - Drain charge	$Q_{gd}$ *5	V <sub>GS</sub> = -10V	-	3.3	-		

## •Body diode electrical characteristics (Source-Drain)(T<sub>a</sub> = 25°C)

Parameter	Symbol Conditions -		Values			Unit
Faranielei			Min.	Тур.	Max.	Unit
Inverse diode continuous, forward current	ا <sub>S</sub> *1	T <sub>a</sub> = 25°C	-	-	-0.8	А
Forward voltage	$V_{SD}$ *5	$V_{GS} = 0V, I_{s} = -4A$	-	-	-1.2	V

\*5 Pulsed



#### Fig.1 Power Dissipation Derating Curve

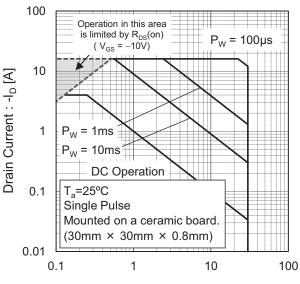
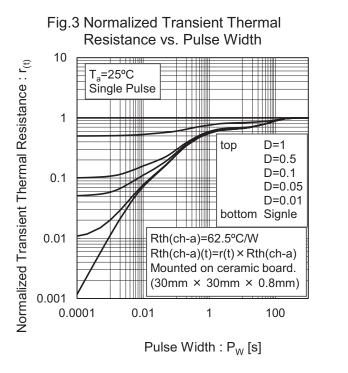
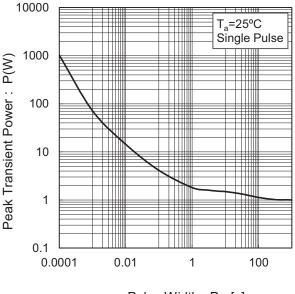


Fig.2 Maximum Safe Operating Area

Drain - Source Voltage : -V<sub>DS</sub> [V]



# Fig.4 Single Pulse Maxmum Power dissipation



Pulse Width : P<sub>W</sub> [s]

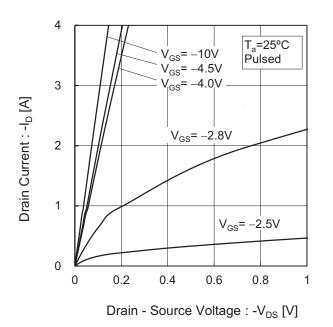
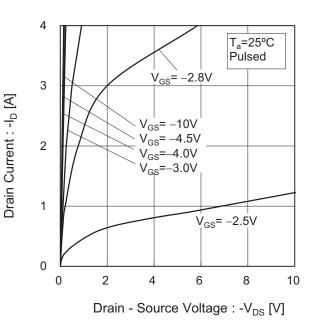
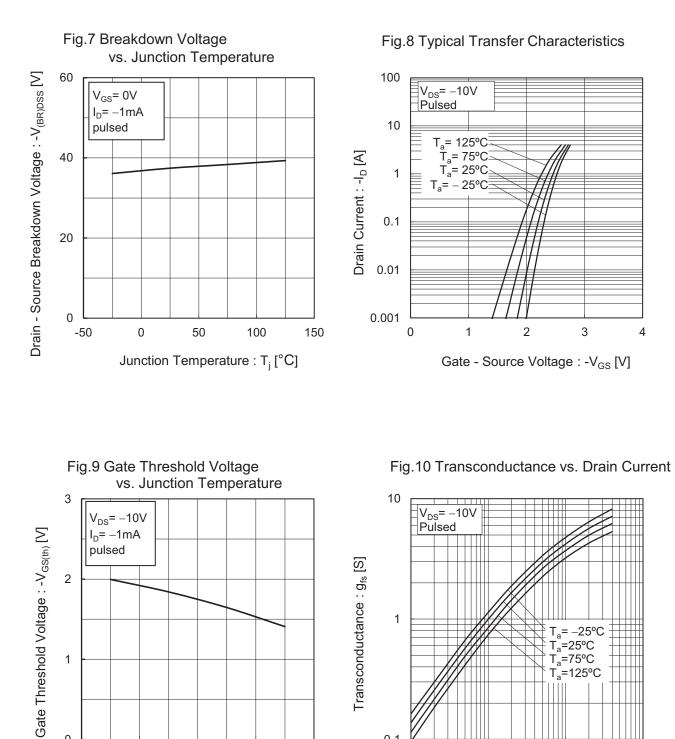


Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)





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0

50

Junction Temperature : T<sub>i</sub> [°C]

100

150

0

-50

1

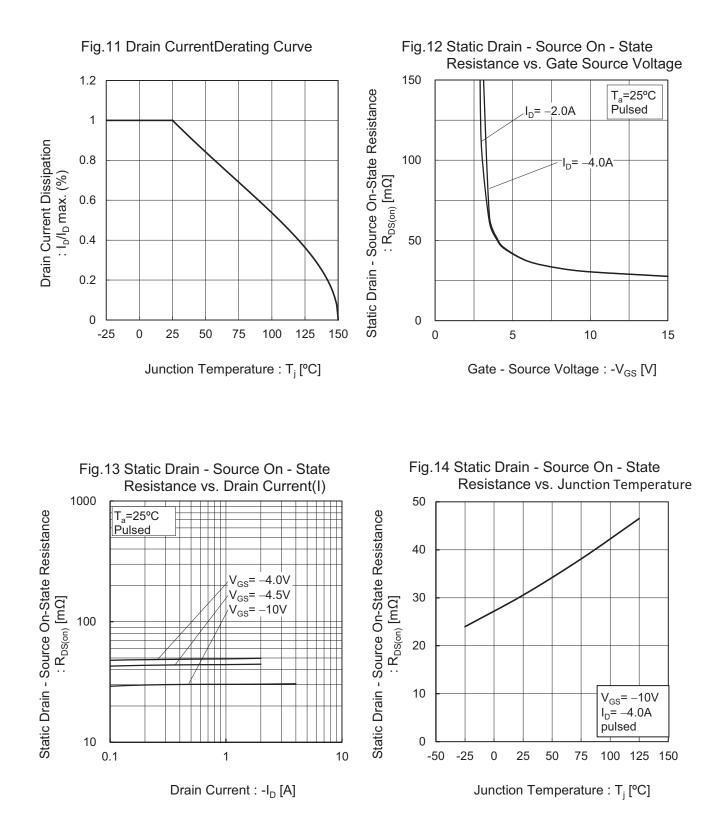
Drain Current : -I<sub>D</sub> [A]

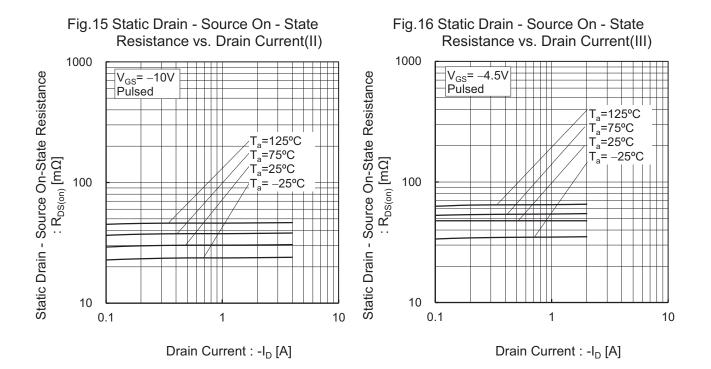
10

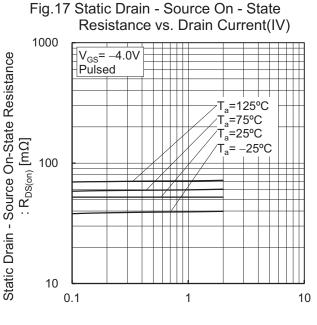
0.1

0.01

0.1

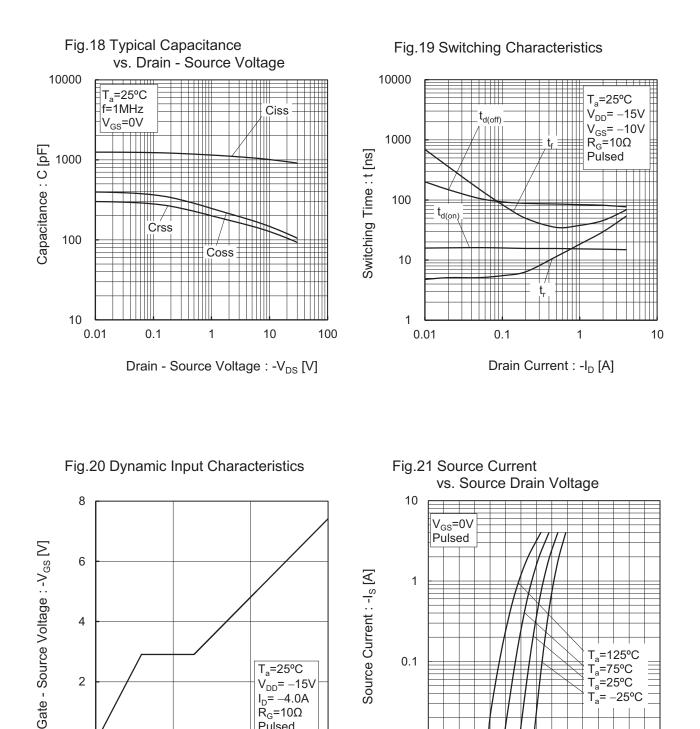






Drain Current : -I<sub>D</sub> [A]





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5

0

0

0.01

0

0.5

 $\ddot{R}_{G}=10\Omega$ Pulsed

15

10

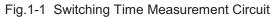
Total Gate Charge : Q<sub>g</sub> [nC]

1

Source-Drain Voltage : -V<sub>SD</sub> [V]

1.5

### •Measurement circuits



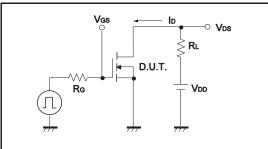


Fig.2-1 Gate Charge Measurement Circuit

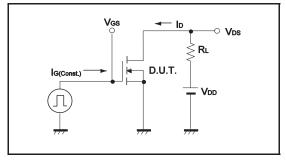
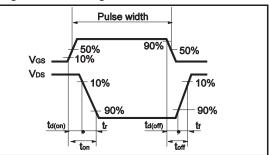
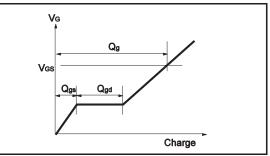


Fig.1-2 Switching Waveforms

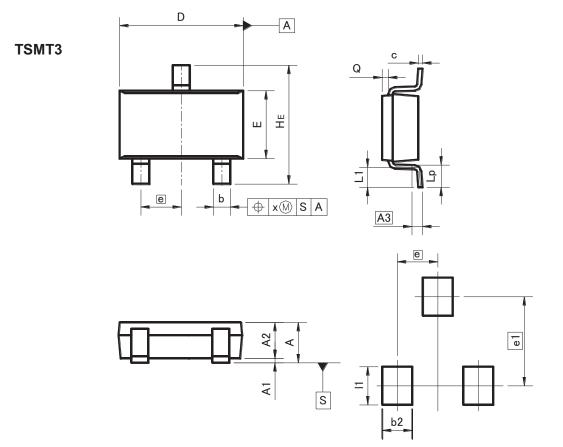








## •Dimensions (Unit : mm)



Patterm of terminal position areas

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
A	-	1.00	-	0.039
A1	0.00	0.10	0	0.004
A2	0.75	0.95	0.03	0.037
A3	0.2	25	0.0	01
b	0.35	0.50	0.014	0.02
с	0.10	0.26	0.004	0.01
D	2.80	3.00	0.11	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.0	04
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.01
х	_	0.20	_	0.008

DIM	MILIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
e1	2.	10	0.08		
b2		0.70	-	0.028	
1	-	0.90	—	0.035	

Dimension in mm/inches

# Notice

#### **Precaution on using ROHM Products**

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA
CLASSI	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSI	CLASSⅢ	CLASSII

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[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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# RRR040P03FRA - Web Page

Part Number	RRR040P03FRA
Package	TSMT3
Unit Quantity	3000
Minimum Package Quantity	3000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes